

Docket No.: I434.108.101/IFT1070US

09-29-2004

TC
Please re

102846902

of.

9.24.04

1. Name of conveying party(ies):

1. Nikolaus Bott;
2. Oliver Haeberlen;
3. Manfred Kotek;

Additional name(s) of conveying party(ies) attached?

☐ No ☒ Yes

3. Nature of conveyance:

- | | |
|--|---|
| <input checked="" type="checkbox"/> Assignment | <input type="checkbox"/> Merger |
| <input type="checkbox"/> Security Agreement | <input type="checkbox"/> Change of Name |
| <input type="checkbox"/> Other | |

Execution Date: August 16, 2004; August 25, 2004; August 13, 2004;
August 26, 2004; August 13, 2004; and August 13, 2004

2. Name and address of receiving party(ies):

Name: Infineon Technologies AG

Internal Address:

Street Address: St. Martin Str. 53

City: Munich State: ZIP: 81541

Country: Germany

Additional name(s) & addresses attached?

☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application Serial No.(s)/Filing Date(s)

10/850,157 May 20, 2004

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Paul P. KempfAddress: DICKE, BILLIG & CZAJA, PLLC
Fifth Street Towers, Suite 2250
100 South Fifth Street
Minneapolis, MN 55402

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41). \$40.00

- ☐ Enclosed.
- ☒ The Patent Office is hereby authorized to charge Deposit Acct. No. 50-0471 in the amount of \$40.00 for recording of the Assignment document.
- ☒ Any deficiencies in enclosed fees should be charged to deposit account 50-0471.

8. Deposit Account Number: 50-0471

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Paul P. Kempf

(Name of Person Signing)

[Signature]
Signature9/21/04
Date

Total number of pages comprising cover sheet, attachments and document: 14

OMB No. 0651-0011 (exp. 4/94)

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PATENT
REEL: 015821 FRAME: 0865

Recordation Form Cover Sheet

Additional Name(s) of Conveying Party(ies)

4. Joost Larik;
5. Josef Maerz; and
6. Ralf Otremba

ASSIGNMENT

For good and valuable consideration, I, Nikolaus Bott, a citizen of Germany, residing at Franz-Pehr-Straße 16, A-9500 Villach, Austria; Oliver Haeberlen, a citizen of Germany, residing at Paulapromenade 1, A-9500 Villach, Austria; Manfred Kotek, a citizen of Austria, residing at Franz-Pehr-Straße 7 b, A-9500 Villach, Austria; Joost Larik, a citizen of the Netherlands, residing at Mitterfeldring 118, D-85586 Poing, Germany; Josef Maerz, a citizen of Germany, residing at Schraudolphstraße 15A, 80799 München, Germany; and Ralf Otremba, a citizen of Germany, residing at Ahornstraße 42, 87600 Kaufbeuren, Germany; hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81541, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on May 20, 2004

US. Serial No. 10/850,157,

entitled: SEMICONDUCTOR ARRANGEMENT

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:


NAME: Nikolaus Bott

DATE:

2004-08-16

SIGNATURE: _____ DATE: _____
NAME: Oliver Haeberlen

SIGNATURE: _____ DATE: _____
NAME: Manfred Kotek

SIGNATURE: _____ DATE: _____
NAME: Joost Larik

SIGNATURE: _____ DATE: _____
NAME: Josef Maerz

SIGNATURE: _____ DATE: _____
NAME: Ralf Otremba

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SIGNATURE: _____ DATE: _____
NAME: Nikolaus Bott

SIGNATURE: Oliver Haeberlen DATE: 25.08.2004
NAME: Oliver Haeberlen

SIGNATURE: _____ DATE: _____
NAME: Manfred Kotek

SIGNATURE: _____ DATE: _____
NAME: Joost Larik

SIGNATURE: _____ DATE: _____
NAME: Josef Maerz

SIGNATURE: _____ DATE: _____
NAME: Ralf Otremba

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SIGNATURE: _____ DATE: _____
NAME: Nikolaus Bott

SIGNATURE: _____ DATE: _____
NAME: Oliver Haeberlen

SIGNATURE: Manfred Kotek DATE: 13.8.04
NAME: Manfred Kotek

SIGNATURE: _____ DATE: _____
NAME: Joost Larik

SIGNATURE: _____ DATE: _____
NAME: Josef Maerz

SIGNATURE: _____ DATE: _____
NAME: Ralf Otremba

ASSIGNMENT

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Arnulfweg 7, A-9500 Villach, Austria

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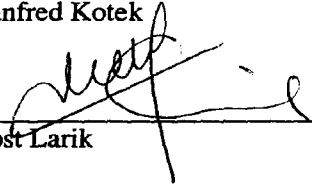
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NAME: Nikolaus Bott

SIGNATURE: _____ DATE: _____
NAME: Oliver Haeberlen

SIGNATURE: _____ DATE: _____
NAME: Manfred Kotek

SIGNATURE:  _____ DATE: 26.08.04
NAME: Joost Larik

SIGNATURE: _____ DATE: _____
NAME: Josef Maerz

SIGNATURE: _____ DATE: _____
NAME: Ralf Otremba

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NAME: Manfred Kotek

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SIGNATURE:  _____ DATE: 13.08.2004
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NAME: Ralf Otremba